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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Applicant:

2814

Ilya Karpov et al.

800000 Examiner:

Serial No.:

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Docket:

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For:

Fabricating Deeper and

§ § Assignee:

Intel Corporation

Shallower Trenches in

Semiconductor Structures

Conf. No.

Art Unit:

3077

Mail Stop AF Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

REPLY TO FINAL REJECTION

Sir:

In response to the final rejection mailed August 15, 2007, please amend the abovereferenced patent application as follows:

Date of Geposit: <u>Sentember 20, 2007</u>
I hereby certify that this document is being sessimile transmitted to the united States Patent and Trademark Office (Pay No. 571/3/3-8300) on the